



**LEGEND**

C1=Cin	R2=Ruvlo2	J2=DNP
C2=Csep	R3=Ruvlo1	L1=Lin/Lout
C3=DNP	R4=DNP	M1=Q1
C4=Ccomp1	R5=Rfb1	
C5=Ccomp2	R6=Rfb2	
C6=Cramp	R7=DNP	
C7=Ccc	R8=Rsense	
C8=Cbp	R9=Rcomp	
C9,C10,C11=DNP	R10=Rfadj	
C12=Cout		

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Number: PMP9332	Rev: E1	Designed for: Public	Mod. Date: 12/16/2013
SVN Rev: Not in version control	Assembly Variant: Variant name not interpreted	Project Title: Power Supply 4A	Sheet Title:
Drawn By:	File: PMP9332_ANSI-B_SchDoc	Sheet: 1 of 1	Size: B
Engineer: David baba	Contact: <a href="http://www.ti.com/support">http://www.ti.com/support</a>		



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